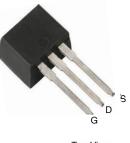


270N4F3-VB TO262 Datasheet

N-Channel 40 V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | |
|---------------------|----------------------------------|------------------------------------|-----------------------|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) ^{a, c} | Q _g (Typ.) | | |
| 40 | 0.0017 at V _{GS} = 10 V | 150 | 120 nC | | |
| 40 | 0.0025 at V_{GS} = 4.5 V | 135 | 120110 | | |





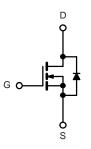
Top View

FEATURES

- TrenchFET[®] Power MOSFET
- 100 % $\rm R_g$ and UIS Tested

APPLICATIONS

- Synchronous Rectification
- Power Supplies



N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS | S T _A = 25 °C, unles | ss otherwise no | oted | |
|--|--|-----------------|---------------------|----|
| Parameter | Symbol | Limit | Unit | |
| Drain-Source Voltage | V _{DS} | 40 | V | |
| Gate-Source Voltage | V _{GS} | ± 25 | - v | |
| | T _C = 25 °C | | 150 ^{a, c} | |
| Continuous Drain Current (T 175 °C) | T _C = 70 °C | | 120 ^c | |
| Continuous Drain Current (T _J = 175 °C) | T _A = 25 °C | Ι _D | 29 ^b | А |
| | T _A = 70 °C | | 23 ^b | |
| Pulsed Drain Current | I _{DM} | 380 | | |
| Avalanche Current Pulse | | I _{AS} | 80 | |
| Single Pulse Avalanche Energy | L = 0.1 mH | E _{AS} | 320 | mJ |
| Continuous Source Drain Diado Current | T _C = 25 °C | L. | 110 ^{a, c} | А |
| Continuous Source-Drain Diode Current | T _A = 25 °C | I _S | 2.6 ^b | |
| | T _C = 25 °C | | 312 ^a | |
| Mariana Distribution | T _C = 70 °C | | 200 | |
| Maximum Power Dissipation | T _A = 25 °C | PD | 3.13 ^b | W |
| | T _A = 70 °C | F | 2.0 ^b | |
| Operating Junction and Storage Temperature Ra | T _J , T _{stg} | - 55 to 150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|--|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^b | Steady State | R _{thJA} | 32 | 40 | °C/W | |
| Maximum Junction-to-Case | Steady State | R _{thJC} | 0.33 | 0.4 | 0/11 | |

Notes:

a. Based on T_C = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. Calculated based on maximum junction temperature. Package limitation current is 110 A.

1



| SPECIFICATIONS T _J = 25 °C, unless otherwise noted | | | | | | | |
|--|-------------------------|--|--------|--------|-------|-------|--|
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
| Static | | | • | • | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 V, I_D = 250 \mu A$ | 45 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I _D = 250 μA | | 41 | | mV/°C | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | i _D = 200 μA | | - 8 | | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | 1.2 | | 2.5 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 100 | nA | |
| Zara Gata Voltaga Drain Current | la en | $V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | | 1 | | |
| Zero Gate Voltage Drain Current | IDSS | $V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$ | | | 10 | μA | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$ | 120 | | | А | |
| | P | V _{GS} = 10 V, I _D = 30 A | 0.0017 | | | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$ | | 0.0025 | | Ω | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 30 A | | 180 | | S | |
| Dynamic ^b | | | | • | | | |
| Input Capacitance | C _{iss} | | | 9000 | | pF | |
| Output Capacitance | C _{oss} | V_{DS} = 20 V, V_{GS} = 0 V, f = 1 MHz | | 650 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 450 | | | |
| Total Gate Charge | Qg | | | 120 | 180 | | |
| Gate-Source Charge | Q _{gs} | $V_{DS} = 20$ V, $V_{GS} = 10$ V, $I_{D} = 20$ A | | 30 | | nC | |
| Gate-Drain Charge | Q _{gd} | | | 16 | | | |
| Gate Resistance | Rg | f = 1 MHz | | 0.85 | 1.3 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 20 | 30 | | |
| Rise Time | t _r | V_{DD} = 20 V, R_L = 1.0 Ω | | 11 | 17 | | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong$ 20 A, V_{GEN} = 10 V, R_g = 1 Ω | | 77 | 115 | | |
| Fall Time | t _f | | | 10 | 15 | | |
| Turn-On Delay Time | t _{d(on)} | | | 102 | 155 | ns | |
| Rise Time | t _r | V_{DD} = 20 V, R_{L} = 1.0 Ω | | 62 | 95 | - | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong 20$ A, V_{GEN} = 4.5 V, R_g = 1 Ω | | 180 | 270 | | |
| Fall Time | t _f | | | 60 | 90 | | |
| Drain-Source Body Diode Characteristic | s | | | | | | |
| Continuous Source-Drain Diode Current | ۱ _S | T _C = 25 °C | | | 110 | A | |
| Pulse Diode Forward Current ^a | I _{SM} | | | | 200 | | |
| Body Diode Voltage | V _{SD} | I _S = 20 A | | 0.8 | 1.2 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 50 | 75 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | L = 20 A di/dt = 100 A/up T = 25 °C | | 70 | 105 | nC | |
| Reverse Recovery Fall Time | t _a | I _F = 20 A, di/dt = 100 A/μs, T _J = 25 °C | | 30 | | | |
| Reverse Recovery Rise Time | t _b | | | 20 | | ns | |

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

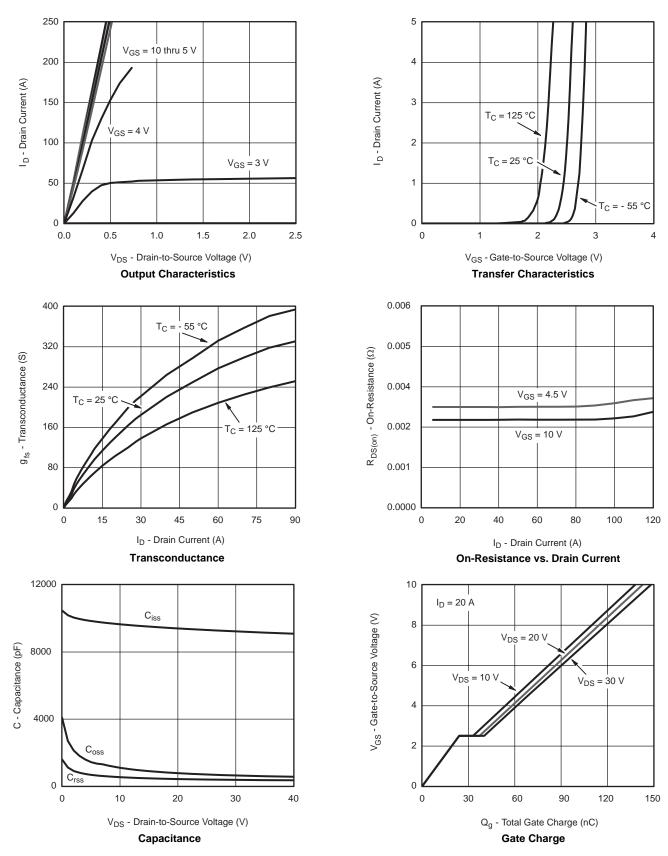
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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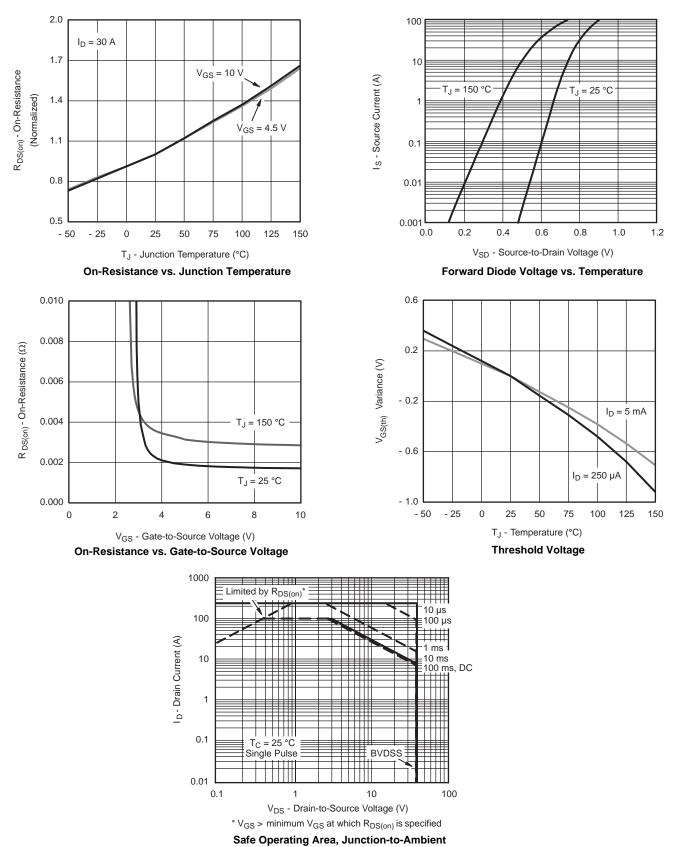
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



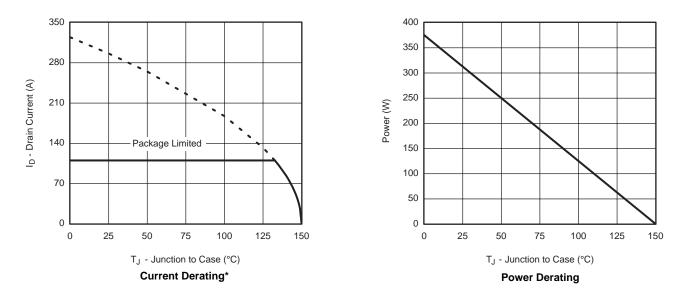
服务热线:400-655-8788



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

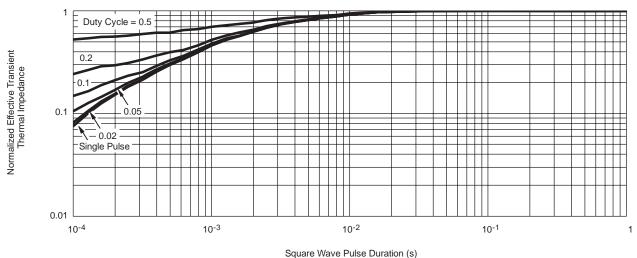






TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

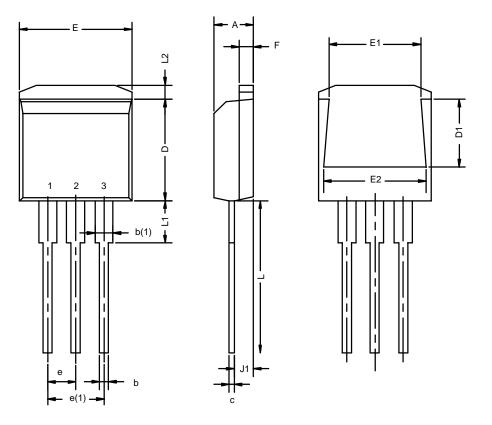


Normalized Thermal Transient Impedance, Junction-to-Case

270N4F3-VB TO262



TO-262: 3-LEAD



| | MILLIM | ETERS* | INC | INCHES | | |
|---|--------|--------|-------|--------|--|--|
| Dim | Min | Max | Min | Max | | |
| Α | 4.32 | 4.70 | 0.170 | 0.185 | | |
| b | 0.64 | 1.00 | 0.025 | 0.039 | | |
| b(1) | 1.14 | 1.40 | 0.045 | 0.055 | | |
| С | 0.36 | 0.50 | 0.014 | 0.020 | | |
| D | 8.64 | 9.65 | 0.340 | 0.380 | | |
| D1 | 5.59 | 6.10 | 0.220 | 0.240 | | |
| е | 2.41 | 2.67 | 0.095 | 0.105 | | |
| e(1) | 4.95 | 5.33 | 0.195 | 0.210 | | |
| E | 10.03 | 10.41 | 0.395 | 0.410 | | |
| E1 | 7.87 | 8.64 | 0.310 | 0.340 | | |
| E2 | 9.02 | 9.53 | 0.355 | 0.375 | | |
| F | 1.14 | 1.40 | 0.045 | 0.055 | | |
| J1 | 2.41 | 2.79 | 0.095 | 0.110 | | |
| L | 13.08 | 14.22 | 0.515 | 0.560 | | |
| L1 | - | 3.81 | - | 0.150 | | |
| L2 | 1.02 | 1.40 | 0.040 | 0.055 | | |
| ECN: T-02234—Rev. C, 14-Oct-02 DWG: 5855 | | | | | | |

*Use millimeters as the primary measurement



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